### Sensors and Materials

## Special Issue on Sensor Technologies in Infrared Region and Their Application

# Call for Papers

Research on the application of infrared light has recently attracted attention. It is important to develop materials, devices, sensor technologies, and light sources as device technologies for this application. In this special issue, we solicit reports on advances in device technologies and the application of infrared light. Reports on device technologies include proposals of materials, sensing devices, sensor technologies, and light sources in the infrared region. Reports on the application of infrared light include its application to new research fields including semiconductors, communications, laser processing, medical devices, and agriculture.

### Scope:

- Materials, sensing devices, sensor technologies, and light sources in the infrared region
- Application of infrared light to new research fields including semiconductors, communications, laser processing, medical devices, and agriculture

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**Guest Editor:** 

Prof. Satoshi Wada (RIKEN)

**Submit to:** 

Online Manuscript Submission System (https://myukk-org.ssl-xserver.jp/form/)

#### (Attention)

As stated in Instructions to Authors in the Guidelines, the author(s) will be obliged to pay the publication fee upon the acceptance of the manuscript for publication (for example, JPY 112200 for 10 pages in Sensors and Materials format). If the quality of the English of your manuscript does not satisfy the journal standards, the authors should bear the proofreading fee (JPY 10000–40000), which will be charged with the publication fee.

If you have any questions, please feel free to contact the editorial staff at the address below.

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